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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/687,199	10/16/2003	Lakhbeer S. Sidhu	A1186	7140
45851	7590 03/08/2005		EXAMINER	
G. VICTOR TREYZ FLOOD BUILDING			TRAN, MAI HUONG C	
870 MARKET STREET, SUITE 984		ART UNIT	PAPER NUMBER	
SAN FRANCISCO, CA 94102			2818	
			DATE MAILED: 03/08/2005	

Please find below and/or attached an Office communication concerning this application or proceeding.

		1					
Office Action Summary		Application No.	Applicant(s)				
		10/687,199	SIDHU ET AL.				
		Examiner	Art Unit				
		Mai-Huong Tran	2818				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply							
THE - Exte after - If the - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPLY MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. se period for reply specified above is less than thirty (30) days, a reply operiod for reply is specified above, the maximum statutory period we are to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be time within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from cause the application to become ABANDONEI	nely filed s will be considered timely. the mailing date of this communication. O (35 U.S.C. § 133).				
Status							
1)	Responsive to communication(s) filed on 16 Fe	ebruary 2005.					
2a)□	This action is FINAL . 2b)⊠ This action is non-final.						
3)□	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Disposit	ion of Claims						
5)□ 6)⊠ 7)□	6)⊠ Claim(s) <u>1-13,16-19,22-24 and 30-36</u> is/are rejected.						
Applicati	ion Papers						
10)⊠	The specification is objected to by the Examine The drawing(s) filed on <u>16 October 2003</u> is/are: Applicant may not request that any objection to the Replacement drawing sheet(s) including the correction The oath or declaration is objected to by the Ex	a) accepted or b) dobjected drawing(s) be held in abeyance. See ton is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).				
Priority u	ınder 35 U.S.C. § 119						
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 							
	t(s) e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948)	4)					
3) 🛛 Inform	nation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) r No(s)/Mail Date 10/16/03.		atent Application (PTO-152)				

DETAILED ACTION

Election/Restriction

Application's election without traverse of Group I (Claims 1-19 and 22-36) drawn to a semiconductor device is acknowledged for prosecution in the subject application.

Accordingly, claims 20-21 are withdrawn from consideration as being directed to a non-elected invention. See 37 CFR 1.142(b) and MPEP § 821.03.

Applicants have the right to file a divisional application covering the subject matter of the non-elected claims.

Drawings

The drawings are objected to for the following reasons.

Formal drawing is required for clarity.

Claim Rejections - 35 U.S.C. § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1-8, 10-11, 13, 16-19, 22, 30-36 are rejected under 35 U. S. C. § 102 (e) as being anticipated by U.S. Patent No. 6,624,499 to Kothandaraman et al.

Regarding to claim 1, Kothandaraman discloses a fuse formed on an integrated circuit substrate, comprising a fuse link 106 that is programmed by applying a programming current (col. 3, lines 21-55); and at least one heat sink structure 401 (cols. 3-4, figs. 8A, 8B). The intended use limitation ('wherein when the programming current is being applied, at least part of the at least one heat sink structure carries heat from the fuse link to the integrated circuit substrate without carrying current') does not structurally distinguish the claimed invention over Kothandaraman's reference.

Regarding to claims 2 and 32, the fuse wherein the fuse link comprises polysilicon (col. 5, lines (38-43).

Regarding to claims 3 and 31, the fuse wherein the fuse link comprises crystalline silicon (col. 5, lines (38-43).

Regarding to claim 4, the fuse wherein the fuse link comprises crystalline silicon having a p-n junction (col. 6, lines 54-55).

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Regarding to claims 5 and 33, the fuse wherein the fuse link comprises crystalline silicon having a silicide coating and having a p-n junction (cols. 3-6).

Regarding to claim 6, the fuse wherein the fuse link comprises polysilicon covered with a layer of material having a lower resistivity than the polysilicon (col. 6, lines 21-22).

Regarding to claims 7 and 34-35, the fuse wherein the fuse link comprises polysilicon 112; and a layer of silicide 114 on top of the polysilicon (col. 5, lines 58-64).

Regarding to claim 8, the fuse wherein the fuse link comprises a silicided polysilicon link and wherein the at least one heat sink structure comprises a separate heat sink at either end of the fuse link (col. 4, lines 25-38, and fig. 8A).

Regarding to claim 10, the fuse wherein the at least one heat sink structure comprises metal that conveys heat from the fuse to the substrate without conducting current (col. 4, lines 35-38).

Regarding to claims 11 and 23-24, the fuse wherein the at least one heat sink structure comprises at least one metal-filled contact hole that conveys heat from the fuse to the substrate without conducting current (col. 4, lines 25-38).

Regarding to claim 13, the fuse wherein the fuse link comprises polysilicon with a layer of silicide, wherein the layer of silicide has a current-crowding structure that crowds the programming current applied to the fuse link (col. 3, lines 22-67, col. 4, lines 1-2).

Regarding to claim 16, the fuse wherein the fuse link comprises polysilicon having a p-type region and an n-type region that form a p-n junction (col. 6, lines 54-61).

Regarding to claim 17, the fuse wherein the fuse link comprises polysilicon having a p-n junction and a silicide layer having a narrowed portion located at the p-n junction (col. 6, lines 54-61).

Regarding to claim 18, the fuse wherein the at least one heat sink structure helps to blow the fuse at a given position within the fuse link and wherein the fuse link comprises polysilicon having a p-n junction at the given position (col. 6, lines 54-61).

Regarding to claim 19, the fuse wherein the at least one heat sink structure helps to blow the fuse at a given position within the fuse link, wherein the fuse link comprises polysilicon having a p-n junction at the given position, and wherein the fuse further comprises a silicide layer on the polysilicon having a narrowed region that crowds the programming current in the silicide layer during programming (cols. 3-6).

Regarding to claims 22, Kothandaraman et al. disclose a fuse on an integrated circuit substrate comprising a fuse link having a polysilicon line and a layer of silicide on the polysilicon line, wherein the fuse link has first and second ends; and first and second metal lines that apply a programming current to the fuse link that flows from the first end of the fuse link to the second end of the fuse link and programs the fuse link by creating an open circuit in the silicide layer, wherein the polysilicon line comprises a p-type doped region and an n-type doped region that form a p-n junction (cols. 3-6).

Regarding to claim 30, Kothandaraman et al. disclose a fuse on an integrated circuit substrate comprising a fuse link having a semiconductor line and a thin-film conductive layer on the semiconductor line, wherein the fuse link has first and second ends; and first and second metal lines that apply a programming current to the fuse link that flows from the first end of the fuse link to the second end of the fuse link and programs the fuse link by creating an open circuit in the thin-film conductive layer, wherein the semiconductor line comprises a p-type doped region and an n-typed doped region that form a p-n junction (cols. 3-6).

Regarding to claim 36, the fuse wherein the substrate comprises a silicon-on-insulator substrate having a buried oxide layer that is adjacent to the semiconductor line (col. 4, lines 13-67, col. 5, lines 1-22, and fig. 8B).

Claim Rejections - 35 U.S.C. § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 9, 12 are rejected under 35 U.S.C. 103 (a) as being unpatentable over U.S. Patent No. 6,624,499 to Kothandaraman et al. in view of the remark.

Regarding to claim 9, Kothandaraman discloses the fuse wherein the fuse link comprises a silicided polysilicon link and wherein the at least one heat sink structure comprises a separate heat sink at either end of the fuse link (col. 4, lines 25-38, and fig. 8A). However, Kothandaraman doesn't disclose a heat sink at a middle position in the fuse link. It would have been obvious to one of ordinary skill in the art at the time the invention was made to form a heat sink at a middle position in the fuse link, since it has been held that rearranging parts of an invention involves only routine skill in the art. In re Japikse, 86 USPQ 70.

Regarding to claim 12, Kothandaraman discloses the fuse wherein the integrated circuit substrate is covered with a dielectric layer and wherein the at least one heat sink structure comprises first and second metal contacts at either end of the fuse link that convey heat from the fuse link to the integrated circuit substrate. However, Kothandaraman does not disclose the dielectric layer having first and second openings. It would have been obvious to one of ordinary skill in the art at the time the invention was made to form the dielectric layer having first and second openings, since it has been held that rearranging parts of an invention involves only routine skill in the art. In re Japikse, 86 USPQ 70.

Allowable Subject Matter

Claims 14, 15, 25-29 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Conclusion

Any inquiry concerning this communication on earlier communications from the examiner should be directed to Mai-Huong Tran, (571) 272-1796. The examiner can normally be reached on Monday-Thursday from 8:00 AM to 6:30 PM. The examiner's supervisor, David Nelms can be reached on (571) 272-1787.

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The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR, Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Mai-Huong Tran

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